

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT2635206

SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>MASAAKI FUJIMORI</td> <td>11/06/2013</td> </tr> <tr> <td>TOHRU KOHNO</td> <td>11/06/2013</td> </tr> </tbody> </table>		Name	Execution Date	MASAAKI FUJIMORI	11/06/2013	TOHRU KOHNO	11/06/2013
Name	Execution Date						
MASAAKI FUJIMORI	11/06/2013						
TOHRU KOHNO	11/06/2013						
RECEIVING PARTY DATA							
Name:	HITACHI, LTD.						
Street Address:	6-6, MARUNOUCHI 1-CHOME						
City:	CHIYODA-KU, TOKYO						
State/Country:	JAPAN						
PROPERTY NUMBERS Total: 1							
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14075362</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14075362		
Property Type	Number						
Application Number:	14075362						
CORRESPONDENCE DATA							
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NAME OF SUBMITTER:	MICHAEL H. JACOBS						
Signature:	/Michael H. Jacobs/						
Date:	12/03/2013						
Total Attachments: 1 source=66017US_Assignment#page1.tif							

OP \$40.00 14075362

ASSIGNMENT  
(讓渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me by Hitachi, Ltd., a corporation organized under the laws of Japan, located at 6-6, Marunouchi 1-chome, Chiyoda-ku, Tokyo, Japan receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi, Ltd., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

METHOD FOR CALCULATING SOLAR RADIATION AMOUNT AND METHOD FOR DETERMINING POWER TO BE SUPPLIED

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Hitachi, Ltd., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi, Ltd.,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S) (發明者フルネームサイン)	Date Signed (署名日)
1) <u>Masaaki Fujimori</u> Masaaki FUJIMORI	<u>11/6/13</u>
2) <u>Tohru Kohno</u> Tohru KOHNO	<u>11/06/13</u>
3) _____	_____
4) _____	_____
5) _____	_____
6) _____	_____
7) _____	_____
8) _____	_____
9) _____	_____
10) _____	_____

PATENT